

INTERCONNECTS

SERIES 800, 801, 802, 803 • .100" GRID SOLDER CUP HEADERS AND SOCKETS • SINGLE AND DOUBLE ROW STRIPS

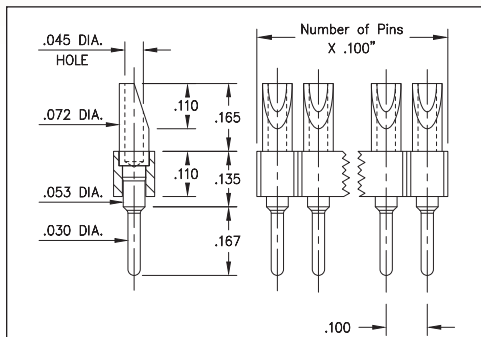


FIG. 1

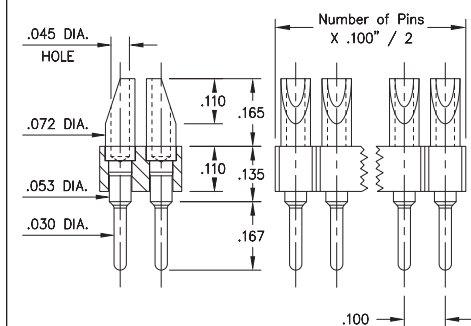


FIG. 2

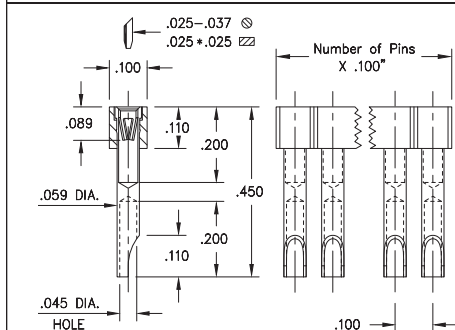


FIG. 3

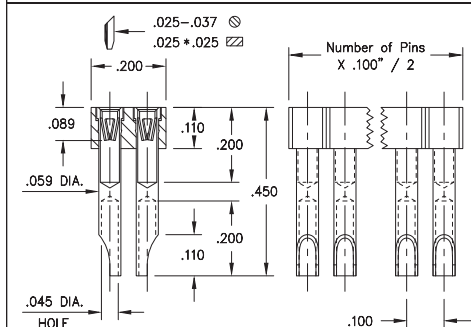


FIG. 4

- Series 800 and 802 use MM #1107 pins. See page 218 for details
- Series 801 and 803 use MM #1134 pin receptacles and accept pin diameters from .025"-.037" and .025" square pins. See page 177 for details
- Series 801 and 803 receptacles use Hi-Rel, 4-finger BeCu #47 contact rated at 4.5 amps. See page 256 for details
- Solder cups are pre-aligned and accept up to 20 AWG wire
- Insulators are high temperature thermoplastic, suitable for all soldering operations



ORDERING INFORMATION

FIG. 1	Series 800...007 Single Row Solder Cup / Solder Tail	
	800-XX-0	-10-007000
	Specify number of pins	02-64
FIG. 2	Series 802...007 Double Row Solder Cup / Solder Tail	
	802-XX-0	-10-007000
	Specify number of pins	02-64
RoHS-2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Environmental Data, See page 264		
SPECIFY PLATING CODE XX=		
Pin Plating 		
	10 	40 
	10 μ " Au	200 μ " Sn

FIG. 3	Series 801...007 Single Row Solder Cup Sockets	
	801-13-0	-10-007000
	Specify number of pins	02-64
FIG. 4	Series 803...007 Double Row Solder Cup Sockets	
	803-13-0	-10-007000
	Specify number of pins	02-64
RoHS-2 2011/65/EU XX=Plating Code See Below For Electrical, Mechanical & Environmental Data, See page 264		
SPECIFY PLATING CODE XX=		
Sleeve (Pin) 		
Contact (Clip) 		
	13 	
	10 μ " Au	
	30 μ " Au	

